

Global SiC Wafer Laser Modified Cutting Equipment Market Research Report 2026(Status and Outlook)

<https://marketpublishers.com/r/G9A4AA11E9D0EN.html>

Date: March 2026

Pages: 141

Price: US\$ 2,980.00 (Single User License)

ID: G9A4AA11E9D0EN

Abstracts

According to our Semiconductor Research Center, in 2022, the global semiconductor equipment was valued at US\$ 109 billion. China mainland, China Taiwan and South Korea have a combined market share over 70%. North America, Europe and Japan, have a combined market share of 23%. The key drivers are high performance computing, AI, cloud computing, Servers, 5G and EV (electric vehicle), etc.

The global Wafer Laser Modified Cutting Equipment market size was estimated at USD 122.0 million in 2025 and is projected to grow at a compound annual growth rate (CAGR) of 12.00% during the forecast period.

This report offers a comprehensive and in-depth analysis of the global Wafer Laser Modified Cutting Equipment market, covering all critical facets from a broad macroeconomic overview to detailed micro-level insights. It examines market size, competitive landscape, emerging development trends, niche segments, key drivers and challenges, as well as conducts SWOT and value chain analyses.

The insights provided enable readers to understand the competitive dynamics within the industry and formulate effective strategies to enhance profitability and market positioning. Additionally, the report presents a clear framework for evaluating the current status and future outlook of business organizations operating in this sector.

A significant focus of this report lies in the competitive landscape of the global Wafer Laser Modified Cutting Equipment market. It offers detailed profiles of major players, including their market shares, performance metrics, product portfolios, and operational status. This enables stakeholders to identify leading competitors and gain a nuanced understanding of market rivalry and structure.

In summary, this report serves as an essential resource for industry participants, investors, researchers, consultants, and business strategists, as well as anyone planning to enter or expand their presence in the Wafer Laser Modified Cutting Equipment market.

Global Wafer Laser Modified Cutting Equipment Market: Market Segmentation Analysis

This research report provides a detailed segmentation of the market by region (country), key manufacturers, product type, and application. Market segmentation divides the overall market into distinct subsets based on factors such as product categories, end-user industries, geographic locations, and other relevant criteria.

A clear understanding of these market segments enables decision-makers to tailor their product development, sales, and marketing strategies more effectively to meet the unique needs of each segment. Leveraging market segmentation insights can significantly enhance targeted approaches, optimize resource allocation, and accelerate product innovation cycles by aligning offerings with the specific demands of diverse customer groups.

Key Company

DISCO
Delphi Laser
Han's Laser
HGLaser
CHN.GIE
DR Laser
Lumi Laser

Market Segmentation (by Type)

Processing Sizes up to 6 Inches
Processing Sizes up to 8 Inches
Processing Sizes up to 12 Inches

Market Segmentation (by Application)

SiC Wafer
GaN Wafer
Other

Geographic Segmentation

North America (USA, Canada, Mexico)
Europe (Germany, UK, France, Russia, Italy, Rest of Europe)
Asia-Pacific (China, Japan, South Korea, India, Southeast Asia, Rest of Asia-Pacific)
South America (Brazil, Argentina, Columbia, Rest of South America)
The Middle East and Africa (Saudi Arabia, UAE, Egypt, Nigeria, South Africa, Rest of MEA)

Key Benefits of This Market Research:

Industry drivers, restraints, and opportunities covered in the study
Neutral perspective on the market performance
Recent industry trends and developments
Competitive landscape & strategies of key players
Potential & niche segments and regions exhibiting promising growth covered
Historical, current, and projected market size, in terms of value
In-depth analysis of the Wafer Laser Modified Cutting Equipment Market
Overview of the regional outlook of the Wafer Laser Modified Cutting Equipment Market:

Customization of the Report

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Chapter Outline

Chapter 1 mainly introduces the statistical scope of the report, market division standards, and market research methods.

Chapter 2 is an executive summary of different market segments (by region, product type, application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the Wafer Laser Modified Cutting Equipment Market and its likely evolution in the short to mid-term, and long term.

Chapter 3 makes a detailed analysis of the market's competitive landscape of the market and provides the market share, capacity, output, price, latest development plan, merger, and acquisition information of the main manufacturers in the market.

Chapter 4 is the analysis of the whole market industrial chain, including the upstream and downstream of the industry, as well as Porter's five forces analysis.

Chapter 5 introduces the latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 6 provides the analysis of various market segments according to product types, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 7 provides the analysis of various market segments according to application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 8 provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and capacity of each country in the world.

Chapter 9 shares the main producing countries of Wafer Laser Modified Cutting Equipment, their output value, profit level, regional supply, production capacity layout, etc. from the supply side.

Chapter 10 introduces the basic situation of the main companies in the market in detail, including product sales revenue, sales volume, price, gross profit margin, market share, product introduction, recent development, etc.

Chapter 11 provides a quantitative analysis of the market size and development potential of each region in the next five years.

Chapter 12 provides a quantitative analysis of the market size and development potential of each market segment in the next five years.

Chapter 13 is the main points and conclusions of the report.

Key Reasons to Buy this Report:

Access to date statistics compiled by our researchers. These provide you with historical and forecast data, which is analyzed to tell you why your market is set to change

This enables you to anticipate market changes to remain ahead of your competitors

You will be able to copy data from the Excel spreadsheet straight into your marketing plans, business presentations, or other strategic documents

The concise analysis, clear graph, and table format will enable you to pinpoint the information you require quickly

Provision of market value data for each segment and sub-segment

Indicates the region and segment that is expected to witness the fastest growth as well as to dominate the market

Analysis by geography highlighting the consumption of the product/service in the region as well as indicating the factors that are affecting the market within each region

Competitive landscape which incorporates the market ranking of the major players, along with new service/product launches, partnerships, business expansions, and acquisitions in the past five years of companies profiled

Extensive company profiles comprising of company overview, company insights, product benchmarking, and SWOT analysis for the major market players

The current as well as the future market outlook of the industry concerning recent developments which involve growth opportunities and drivers as well as challenges and restraints of both emerging as well as developed regions

Includes in-depth analysis of the market from various perspectives through Porter's five forces analysis

Provides insight into the market through Value Chain

Market dynamics scenario, along with growth opportunities of the market in the years to come

6-month post-sales analyst support

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Contents

1 RESEARCH METHODOLOGY AND STATISTICAL SCOPE

- 1.1 Market Definition and Statistical Scope of SiC Wafer Laser Modified Cutting Equipment
- 1.2 Key Market Segments
 - 1.2.1 SiC Wafer Laser Modified Cutting Equipment Segment by Type
 - 1.2.2 SiC Wafer Laser Modified Cutting Equipment Segment by Application
- 1.3 Methodology & Sources of Information
 - 1.3.1 Research Methodology
 - 1.3.2 Research Process
 - 1.3.3 Market Breakdown and Data Triangulation
 - 1.3.4 Base Year
 - 1.3.5 Report Assumptions & Caveats

2 SIC WAFER LASER MODIFIED CUTTING EQUIPMENT MARKET OVERVIEW

- 2.1 Global Market Overview
 - 2.1.1 Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) Estimates and Forecasts (2020-2035)
 - 2.1.2 Global SiC Wafer Laser Modified Cutting Equipment Sales Estimates and Forecasts (2020-2035)
- 2.2 Market Segment Executive Summary
- 2.3 Global Market Size by Region

3 SIC WAFER LASER MODIFIED CUTTING EQUIPMENT MARKET COMPETITIVE LANDSCAPE

- 3.1 Company Assessment Quadrant
- 3.2 Global SiC Wafer Laser Modified Cutting Equipment Product Life Cycle
- 3.3 Global SiC Wafer Laser Modified Cutting Equipment Sales by Manufacturers (2020-2025)
- 3.4 Global SiC Wafer Laser Modified Cutting Equipment Revenue Market Share by Manufacturers (2020-2025)
- 3.5 SiC Wafer Laser Modified Cutting Equipment Market Share by Company Type (Tier 1, Tier 2, and Tier 3)
- 3.6 Global SiC Wafer Laser Modified Cutting Equipment Average Price by Manufacturers (2020-2025)

- 3.7 Manufacturers? Manufacturing Sites, Areas Served, and Product Types
- 3.8 SiC Wafer Laser Modified Cutting Equipment Market Competitive Situation and Trends
 - 3.8.1 SiC Wafer Laser Modified Cutting Equipment Market Concentration Rate
 - 3.8.2 Global 5 and 10 Largest SiC Wafer Laser Modified Cutting Equipment Players
- Market Share by Revenue
 - 3.8.3 Mergers & Acquisitions, Expansion

4 SIC WAFER LASER MODIFIED CUTTING EQUIPMENT INDUSTRY CHAIN ANALYSIS

- 4.1 SiC Wafer Laser Modified Cutting Equipment Industry Chain Analysis
- 4.2 Market Overview of Key Raw Materials
- 4.3 Midstream Market Analysis
- 4.4 Downstream Customer Analysis

5 THE DEVELOPMENT AND DYNAMICS OF SIC WAFER LASER MODIFIED CUTTING EQUIPMENT MARKET

- 5.1 Key Development Trends
- 5.2 Driving Factors
- 5.3 Market Challenges
- 5.4 Industry News
 - 5.4.1 New Product Developments
 - 5.4.2 Mergers & Acquisitions
 - 5.4.3 Expansions
 - 5.4.4 Collaboration/Supply Contracts
- 5.5 PEST Analysis
 - 5.5.1 Industry Policies Analysis
 - 5.5.2 Economic Environment Analysis
 - 5.5.3 Social Environment Analysis
 - 5.5.4 Technological Environment Analysis
- 5.6 Global SiC Wafer Laser Modified Cutting Equipment Market Porter's Five Forces Analysis
 - 5.6.1 Global Trade Frictions
 - 5.6.2 U.S. Tariff Policy ? April 2025
 - 5.6.3 Global Trade Frictions and Their Impacts to SiC Wafer Laser Modified Cutting Equipment Market
- 5.7 ESG Ratings of Leading Companies

6 SiC Wafer Laser Modified Cutting Equipment Market Segmentation by Type

- 6.1 Evaluation Matrix of Segment Market Development Potential (Type)
- 6.2 Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Type (2020-2025)
- 6.3 Global SiC Wafer Laser Modified Cutting Equipment Market Size by Type (2020-2025)
- 6.4 Global SiC Wafer Laser Modified Cutting Equipment Price by Type (2020-2025)

7 SiC Wafer Laser Modified Cutting Equipment Market Segmentation by Application

- 7.1 Evaluation Matrix of Segment Market Development Potential (Application)
- 7.2 Global SiC Wafer Laser Modified Cutting Equipment Market Sales by Application (2020-2025)
- 7.3 Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) by Application (2020-2025)
- 7.4 Global SiC Wafer Laser Modified Cutting Equipment Sales Growth Rate by Application (2020-2025)

8 SiC Wafer Laser Modified Cutting Equipment Market Sales by Region

- 8.1 Global SiC Wafer Laser Modified Cutting Equipment Sales by Region
 - 8.1.1 Global SiC Wafer Laser Modified Cutting Equipment Sales by Region
 - 8.1.2 Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Region
- 8.2 Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region
 - 8.2.1 Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region
 - 8.2.2 Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region
- 8.3 North America
 - 8.3.1 North America SiC Wafer Laser Modified Cutting Equipment Sales by Country
 - 8.3.2 North America SiC Wafer Laser Modified Cutting Equipment Market Size by Country
 - 8.3.3 U.S. Market Overview
 - 8.3.4 Canada Market Overview
 - 8.3.5 Mexico Market Overview

8.4 Europe

8.4.1 Europe SiC Wafer Laser Modified Cutting Equipment Sales by Country

8.4.2 Europe SiC Wafer Laser Modified Cutting Equipment Market Size by Country

8.4.3 Germany Market Overview

8.4.4 France Market Overview

8.4.5 U.K. Market Overview

8.4.6 Italy Market Overview

8.4.7 Spain Market Overview

8.5 Asia Pacific

8.5.1 Asia Pacific SiC Wafer Laser Modified Cutting Equipment Sales by Region

8.5.2 Asia Pacific SiC Wafer Laser Modified Cutting Equipment Market Size by Region

8.5.3 China Market Overview

8.5.4 Japan Market Overview

8.5.5 South Korea Market Overview

8.5.6 India Market Overview

8.5.7 Southeast Asia Market Overview

8.6 South America

8.6.1 South America SiC Wafer Laser Modified Cutting Equipment Sales by Country

8.6.2 South America SiC Wafer Laser Modified Cutting Equipment Market Size by Country

8.6.3 Brazil Market Overview

8.6.4 Argentina Market Overview

8.6.5 Columbia Market Overview

8.7 Middle East and Africa

8.7.1 Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Sales by Region

8.7.2 Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Market Size by Region

8.7.3 Saudi Arabia Market Overview

8.7.4 UAE Market Overview

8.7.5 Egypt Market Overview

8.7.6 Nigeria Market Overview

8.7.7 South Africa Market Overview

9 SiC Wafer Laser Modified Cutting Equipment Market Production by Region

9.1 Global Production of SiC Wafer Laser Modified Cutting Equipment by Region(2020-2025)

9.2 Global SiC Wafer Laser Modified Cutting Equipment Revenue Market Share by Region (2020-2025)

9.3 Global SiC Wafer Laser Modified Cutting Equipment Production, Revenue, Price and Gross Margin (2020-2025)

9.4 North America SiC Wafer Laser Modified Cutting Equipment Production

9.4.1 North America SiC Wafer Laser Modified Cutting Equipment Production Growth Rate (2020-2025)

9.4.2 North America SiC Wafer Laser Modified Cutting Equipment Production, Revenue, Price and Gross Margin (2020-2025)

9.5 Europe SiC Wafer Laser Modified Cutting Equipment Production

9.5.1 Europe SiC Wafer Laser Modified Cutting Equipment Production Growth Rate (2020-2025)

9.5.2 Europe SiC Wafer Laser Modified Cutting Equipment Production, Revenue, Price and Gross Margin (2020-2025)

9.6 Japan SiC Wafer Laser Modified Cutting Equipment Production (2020-2025)

9.6.1 Japan SiC Wafer Laser Modified Cutting Equipment Production Growth Rate (2020-2025)

9.6.2 Japan SiC Wafer Laser Modified Cutting Equipment Production, Revenue, Price and Gross Margin (2020-2025)

9.7 China SiC Wafer Laser Modified Cutting Equipment Production (2020-2025)

9.7.1 China SiC Wafer Laser Modified Cutting Equipment Production Growth Rate (2020-2025)

9.7.2 China SiC Wafer Laser Modified Cutting Equipment Production, Revenue, Price and Gross Margin (2020-2025)

10 KEY COMPANIES PROFILE

10.1 DISCO

10.1.1 DISCO Basic Information

10.1.2 DISCO SiC Wafer Laser Modified Cutting Equipment Product Overview

10.1.3 DISCO SiC Wafer Laser Modified Cutting Equipment Product Market Performance

10.1.4 DISCO Business Overview

10.1.5 DISCO SWOT Analysis

10.1.6 DISCO Recent Developments

10.2 Delphi Laser

10.2.1 Delphi Laser Basic Information

10.2.2 Delphi Laser SiC Wafer Laser Modified Cutting Equipment Product Overview

10.2.3 Delphi Laser SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.2.4 Delphi Laser Business Overview
- 10.2.5 Delphi Laser SWOT Analysis
- 10.2.6 Delphi Laser Recent Developments

10.3 Han's Laser

- 10.3.1 Han's Laser Basic Information
- 10.3.2 Han's Laser SiC Wafer Laser Modified Cutting Equipment Product Overview
- 10.3.3 Han's Laser SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.3.4 Han's Laser Business Overview
- 10.3.5 Han's Laser SWOT Analysis
- 10.3.6 Han's Laser Recent Developments

10.4 HGLaser

- 10.4.1 HGLaser Basic Information
- 10.4.2 HGLaser SiC Wafer Laser Modified Cutting Equipment Product Overview
- 10.4.3 HGLaser SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.4.4 HGLaser Business Overview
- 10.4.5 HGLaser Recent Developments

10.5 CHN.GIE

- 10.5.1 CHN.GIE Basic Information
- 10.5.2 CHN.GIE SiC Wafer Laser Modified Cutting Equipment Product Overview
- 10.5.3 CHN.GIE SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.5.4 CHN.GIE Business Overview
- 10.5.5 CHN.GIE Recent Developments

10.6 DR Laser

- 10.6.1 DR Laser Basic Information
- 10.6.2 DR Laser SiC Wafer Laser Modified Cutting Equipment Product Overview
- 10.6.3 DR Laser SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.6.4 DR Laser Business Overview
- 10.6.5 DR Laser Recent Developments

10.7 Lumi Laser

- 10.7.1 Lumi Laser Basic Information
- 10.7.2 Lumi Laser SiC Wafer Laser Modified Cutting Equipment Product Overview
- 10.7.3 Lumi Laser SiC Wafer Laser Modified Cutting Equipment Product Market

Performance

- 10.7.4 Lumi Laser Business Overview

10.7.5 Lumi Laser Recent Developments

11 SiC Wafer Laser Modified Cutting Equipment Market Forecast by Region

11.1 Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast

11.2 Global SiC Wafer Laser Modified Cutting Equipment Market Forecast by Region

11.2.1 North America Market Size Forecast by Country

11.2.2 Europe SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country

11.2.3 Asia Pacific SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Region

11.2.4 South America SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country

11.2.5 Middle East and Africa Forecasted Sales of SiC Wafer Laser Modified Cutting Equipment by Country

12 Forecast Market by Type and by Application (2026-2035)

12.1 Global SiC Wafer Laser Modified Cutting Equipment Market Forecast by Type (2026-2035)

12.1.1 Global Forecasted Sales of SiC Wafer Laser Modified Cutting Equipment by Type (2026-2035)

12.1.2 Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Type (2026-2035)

12.1.3 Global Forecasted Price of SiC Wafer Laser Modified Cutting Equipment by Type (2026-2035)

12.2 Global SiC Wafer Laser Modified Cutting Equipment Market Forecast by Application (2026-2035)

12.2.1 Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) Forecast by Application

12.2.2 Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) Forecast by Application (2026-2035)

13 Conclusion and Key Findings

List Of Tables

LIST OF TABLES

Table 1. Introduction of the Type

Table 2. Introduction of the Application

Table 3. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Type (M USD)

Table 4. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Application

Table 5. SiC Wafer Laser Modified Cutting Equipment Market Size Comparison by Region (M USD)

Table 6. Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) by Manufacturers (2020-2025)

Table 7. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Manufacturers (2020-2025)

Table 8. Global SiC Wafer Laser Modified Cutting Equipment Revenue (M USD) by Manufacturers (2020-2025)

Table 9. Global SiC Wafer Laser Modified Cutting Equipment Revenue Share by Manufacturers (2020-2025)

Table 10. Company Type (Tier 1, Tier 2, and Tier 3) & (based on the Revenue in SiC Wafer Laser Modified Cutting Equipment as of 2025)

Table 11. Global Market SiC Wafer Laser Modified Cutting Equipment Average Price (USD/Unit) of Key Manufacturers (2020-2025)

Table 12. Manufacturers? Manufacturing Sites, Areas Served

Table 13. Manufacturers? Product Type

Table 14. Global SiC Wafer Laser Modified Cutting Equipment Manufacturers Market Concentration Ratio (CR5 and HHI)

Table 15. Mergers & Acquisitions, Expansion Plans

Table 16. Market Overview of Key Raw Materials

Table 17. Midstream Market Analysis

Table 18. Downstream Customer Analysis

Table 19. Key Development Trends

Table 20. Driving Factors

Table 21. SiC Wafer Laser Modified Cutting Equipment Market Challenges

Table 22. Goldman Sachs' forecast real GDP growth rate for 2025-2026

Table 23. S&P Global ' Forecast Real GDP Growth Rate For 2025-2027

Table 24. World Bank ' Forecast Real GDP Growth Rate For 2025-2026

Table 25. The Tariff Rates Imposed by the United States on Major Commodity Trading

Countries

Table 26. Global SiC Wafer Laser Modified Cutting Equipment Sales by Type (K Units)

Table 27. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Type (M USD)

Table 28. Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) by Type (2020-2025)

Table 29. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Type (2020-2025)

Table 30. Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) by Type (2020-2025)

Table 31. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Type (2020-2025)

Table 32. Global SiC Wafer Laser Modified Cutting Equipment Price (USD/Unit) by Type (2020-2025)

Table 33. Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) by Application

Table 34. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Application

Table 35. Global SiC Wafer Laser Modified Cutting Equipment Sales by Application (2020-2025) & (K Units)

Table 36. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Application (2020-2025)

Table 37. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Application (2020-2025) & (M USD)

Table 38. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Application (2020-2025)

Table 39. Global SiC Wafer Laser Modified Cutting Equipment Sales Growth Rate by Application (2020-2025)

Table 40. Global SiC Wafer Laser Modified Cutting Equipment Sales by Region (2020-2025) & (K Units)

Table 41. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Region (2020-2025)

Table 42. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region (2020-2025) & (M USD)

Table 43. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region (2020-2025)

Table 44. North America SiC Wafer Laser Modified Cutting Equipment Sales by Country (2020-2025) & (K Units)

Table 45. North America SiC Wafer Laser Modified Cutting Equipment Market Size by

Country (2020-2025) & (M USD)

Table 46. Europe SiC Wafer Laser Modified Cutting Equipment Sales by Country (2020-2025) & (K Units)

Table 47. Europe SiC Wafer Laser Modified Cutting Equipment Market Size by Country (2020-2025) & (M USD)

Table 48. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Sales by Region (2020-2025) & (K Units)

Table 49. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Market Size by Region (2020-2025) & (M USD)

Table 50. South America SiC Wafer Laser Modified Cutting Equipment Sales by Country (2020-2025) & (K Units)

Table 51. South America SiC Wafer Laser Modified Cutting Equipment Market Size by Country (2020-2025) & (M USD)

Table 52. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Sales by Region (2020-2025) & (K Units)

Table 53. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Market Size by Region (2020-2025) & (M USD)

Table 54. Global SiC Wafer Laser Modified Cutting Equipment Production (K Units) by Region(2020-2025)

Table 55. Global SiC Wafer Laser Modified Cutting Equipment Revenue (US\$ Million) by Region (2020-2025)

Table 56. Global SiC Wafer Laser Modified Cutting Equipment Revenue Market Share by Region (2020-2025)

Table 57. Global SiC Wafer Laser Modified Cutting Equipment Production (K Units), Revenue (US\$ Million), Price (USD/Unit) and Gross Margin (2020-2025)

Table 58. North America SiC Wafer Laser Modified Cutting Equipment Production (K Units), Revenue (US\$ Million), Price (USD/Unit) and Gross Margin (2020-2025)

Table 59. Europe SiC Wafer Laser Modified Cutting Equipment Production (K Units), Revenue (US\$ Million), Price (USD/Unit) and Gross Margin (2020-2025)

Table 60. Japan SiC Wafer Laser Modified Cutting Equipment Production (K Units), Revenue (US\$ Million), Price (USD/Unit) and Gross Margin (2020-2025)

Table 61. China SiC Wafer Laser Modified Cutting Equipment Production (K Units), Revenue (US\$ Million), Price (USD/Unit) and Gross Margin (2020-2025)

Table 62. DISCO Basic Information

Table 63. DISCO SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 64. DISCO SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 65. DISCO Business Overview

Table 66. DISCO SWOT Analysis

Table 67. DISCO Recent Developments

Table 68. Delphi Laser Basic Information

Table 69. Delphi Laser SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 70. Delphi Laser SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 71. Delphi Laser Business Overview

Table 72. Delphi Laser SWOT Analysis

Table 73. Delphi Laser Recent Developments

Table 74. Han's Laser Basic Information

Table 75. Han's Laser SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 76. Han's Laser SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 77. Han's Laser Business Overview

Table 78. Han's Laser SWOT Analysis

Table 79. Han's Laser Recent Developments

Table 80. HGLaser Basic Information

Table 81. HGLaser SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 82. HGLaser SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 83. HGLaser Business Overview

Table 84. HGLaser Recent Developments

Table 85. CHN.GIE Basic Information

Table 86. CHN.GIE SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 87. CHN.GIE SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 88. CHN.GIE Business Overview

Table 89. CHN.GIE Recent Developments

Table 90. DR Laser Basic Information

Table 91. DR Laser SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 92. DR Laser SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 93. DR Laser Business Overview

Table 94. DR Laser Recent Developments

Table 95. Lumi Laser Basic Information

Table 96. Lumi Laser SiC Wafer Laser Modified Cutting Equipment Product Overview

Table 97. Lumi Laser SiC Wafer Laser Modified Cutting Equipment Sales (K Units), Revenue (M USD), Price (USD/Unit) and Gross Margin (2020-2025)

Table 98. Lumi Laser Business Overview

Table 99. Lumi Laser Recent Developments

Table 100. Global SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Region (2026-2035) & (K Units)

Table 101. Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Region (2026-2035) & (M USD)

Table 102. North America SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Country (2026-2035) & (K Units)

Table 103. North America SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country (2026-2035) & (M USD)

Table 104. Europe SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Country (2026-2035) & (K Units)

Table 105. Europe SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country (2026-2035) & (M USD)

Table 106. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Region (2026-2035) & (K Units)

Table 107. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Region (2026-2035) & (M USD)

Table 108. South America SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Country (2026-2035) & (K Units)

Table 109. South America SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country (2026-2035) & (M USD)

Table 110. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Country (2026-2035) & (Units)

Table 111. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Country (2026-2035) & (M USD)

Table 112. Global SiC Wafer Laser Modified Cutting Equipment Sales Forecast by Type (2026-2035) & (K Units)

Table 113. Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Type (2026-2035) & (M USD)

Table 114. Global SiC Wafer Laser Modified Cutting Equipment Price Forecast by Type (2026-2035) & (USD/Unit)

Table 115. Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) Forecast by Application (2026-2035)

Table 116. Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast by Application (2026-2035) & (M USD)

List Of Figures

LIST OF FIGURES

Figure 1. Product Picture of SiC Wafer Laser Modified Cutting Equipment

Figure 2. Data Triangulation

Figure 3. Key Caveats

Figure 4. Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD), 2025-2035

Figure 5. Global SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) (2020-2035)

Figure 6. Global SiC Wafer Laser Modified Cutting Equipment Sales (K Units) & (2020-2035)

Figure 7. Evaluation Matrix of Segment Market Development Potential (Type)

Figure 8. Evaluation Matrix of Segment Market Development Potential (Application)

Figure 9. Evaluation Matrix of Regional Market Development Potential

Figure 10. SiC Wafer Laser Modified Cutting Equipment Market Size by Country (M USD)

Figure 11. Company Assessment Quadrant

Figure 12. Global SiC Wafer Laser Modified Cutting Equipment Product Life Cycle

Figure 13. SiC Wafer Laser Modified Cutting Equipment Sales Share by Manufacturers in 2025

Figure 14. Global SiC Wafer Laser Modified Cutting Equipment Revenue Share by Manufacturers in 2025

Figure 15. SiC Wafer Laser Modified Cutting Equipment Market Share by Company Type (Tier 1, Tier 2 and Tier 3): 2025

Figure 16. Global Market SiC Wafer Laser Modified Cutting Equipment Average Price (USD/Unit) of Key Manufacturers in 2025

Figure 17. The Global 5 and 10 Largest Players: Market Share by SiC Wafer Laser Modified Cutting Equipment Revenue in 2025

Figure 18. Industry Chain Map of SiC Wafer Laser Modified Cutting Equipment

Figure 19. Global SiC Wafer Laser Modified Cutting Equipment Market PEST Analysis

Figure 20. Global SiC Wafer Laser Modified Cutting Equipment Market Porter's Five Forces Analysis

Figure 21. Global Merchandise Trade as a Percentage Of GDP

Figure 22. US - Imports of Goods by Country

Figure 23. China Exports by Country

Figure 24. ESG Rating Distribution of The Leading Company Compared With Its Peers

Figure 25. Evaluation Matrix of Segment Market Development Potential (Type)

Figure 26. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Type

Figure 27. Sales Market Share of SiC Wafer Laser Modified Cutting Equipment by Type (2020-2025)

Figure 28. Sales Market Share of SiC Wafer Laser Modified Cutting Equipment by Type in 2025

Figure 29. Market Share of SiC Wafer Laser Modified Cutting Equipment by Type (2020-2025)

Figure 30. Market Share of SiC Wafer Laser Modified Cutting Equipment by Type in 2025

Figure 31. Evaluation Matrix of Segment Market Development Potential (Application)

Figure 32. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Application

Figure 33. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Application (2020-2025)

Figure 34. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Application in 2025

Figure 35. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Application (2020-2025)

Figure 36. Global SiC Wafer Laser Modified Cutting Equipment Market Share by Application in 2025

Figure 37. Global SiC Wafer Laser Modified Cutting Equipment Sales Growth Rate by Application (2020-2025)

Figure 38. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Region (2020-2025)

Figure 39. Global SiC Wafer Laser Modified Cutting Equipment Market Size by Region (2020-2025)

Figure 40. North America SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 41. North America SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 42. North America SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Country in 2024

Figure 43. North America SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 44. North America SiC Wafer Laser Modified Cutting Equipment Market Size by Country in 2024

Figure 45. U.S. SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 46. U.S. SiC Wafer Laser Modified Cutting Equipment Market Size and Growth

Rate (2020-2025) & (M USD)

Figure 47. Canada SiC Wafer Laser Modified Cutting Equipment Sales (K Units) and Growth Rate (2020-2025)

Figure 48. Canada SiC Wafer Laser Modified Cutting Equipment Market Size (M USD) and Growth Rate (2020-2025)

Figure 49. Mexico SiC Wafer Laser Modified Cutting Equipment Sales (Units) and Growth Rate (2020-2025)

Figure 50. Mexico SiC Wafer Laser Modified Cutting Equipment Market Size (Units) and Growth Rate (2020-2025)

Figure 51. Europe SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 52. Europe SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Country in 2024

Figure 53. Europe SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 54. Europe SiC Wafer Laser Modified Cutting Equipment Market Size by Country in 2024

Figure 55. Germany SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 56. Germany SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 57. France SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 58. France SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 59. U.K. SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 60. U.K. SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 61. Italy SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 62. Italy SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 63. Spain SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 64. Spain SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 65. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (K Units)

Figure 66. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Region in 2024

Figure 67. Asia Pacific SiC Wafer Laser Modified Cutting Equipment Market Size by Region in 2024

Figure 68. China SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 69. China SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 70. Japan SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 71. Japan SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 72. South Korea SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 73. South Korea SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 74. India SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 75. India SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 76. Southeast Asia SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 77. Southeast Asia SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 78. South America SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (K Units)

Figure 79. South America SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Country in 2024

Figure 80. South America SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (M USD)

Figure 81. South America SiC Wafer Laser Modified Cutting Equipment Market Size by Country in 2024

Figure 82. Brazil SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 83. Brazil SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 84. Argentina SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 85. Argentina SiC Wafer Laser Modified Cutting Equipment Market Size and

Growth Rate (2020-2025) & (M USD)

Figure 86. Columbia SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 87. Columbia SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 88. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (K Units)

Figure 89. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Sales Market Share by Region in 2024

Figure 90. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (M USD)

Figure 91. Middle East and Africa SiC Wafer Laser Modified Cutting Equipment Market Size by Region in 2024

Figure 92. Saudi Arabia SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 93. Saudi Arabia SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 94. UAE SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 95. UAE SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 96. Egypt SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 97. Egypt SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 98. Nigeria SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 99. Nigeria SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 100. South Africa SiC Wafer Laser Modified Cutting Equipment Sales and Growth Rate (2020-2025) & (K Units)

Figure 101. South Africa SiC Wafer Laser Modified Cutting Equipment Market Size and Growth Rate (2020-2025) & (M USD)

Figure 102. Global SiC Wafer Laser Modified Cutting Equipment Production Market Share by Region (2020-2025)

Figure 103. North America SiC Wafer Laser Modified Cutting Equipment Production (K Units) Growth Rate (2020-2025)

Figure 104. Europe SiC Wafer Laser Modified Cutting Equipment Production (K Units) Growth Rate (2020-2025)

Figure 105. Japan SiC Wafer Laser Modified Cutting Equipment Production (K Units)
Growth Rate (2020-2025)

Figure 106. China SiC Wafer Laser Modified Cutting Equipment Production (K Units)
Growth Rate (2020-2025)

Figure 107. Global SiC Wafer Laser Modified Cutting Equipment Sales Forecast by
Volume (2020-2035) & (K Units)

Figure 108. Global SiC Wafer Laser Modified Cutting Equipment Market Size Forecast
by Value (2020-2035) & (M USD)

Figure 109. Global SiC Wafer Laser Modified Cutting Equipment Sales Market Share
Forecast by Type (2026-2035)

Figure 110. Global SiC Wafer Laser Modified Cutting Equipment Market Share Forecast
by Type (2026-2035)

Figure 111. Global SiC Wafer Laser Modified Cutting Equipment Sales Forecast by
Application (2026-2035)

Figure 112. Global SiC Wafer Laser Modified Cutting Equipment Market Share Forecast
by Application (2026-2035)

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